

BASICS & STATE OF THE ART OF SINGLE-PHOTON LASER TESTING METHODOLOGIES

Montpellier University, 9th of October 2017

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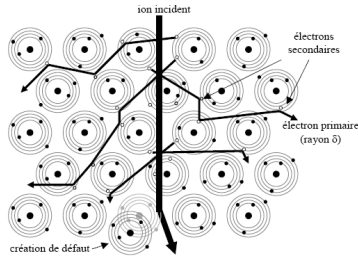
CONTEXT & OUTLINES

- ❑ Laser has demonstrated to be a very interesting tool, complementary to accelerators for the radiation sensitivity assessment

- ❑ Over the past years :
 - Many papers featuring laser tests
 - More groups developing their own facilities
 - Initiatives to compare laser facilities

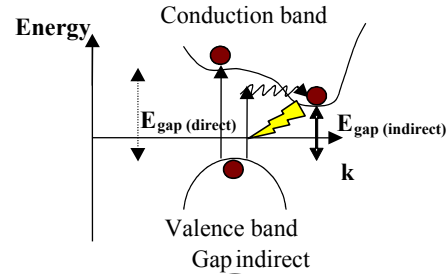
- ❑ Main methodologies:
 - Worst case analysis
 - Parametric testing
 - Fault injection
 - Functional reverse engineering
 - Cross section estimation

BASIC MECHANISMS



Ion/Si

V. Pouget - 2000



SPA Laser/Si

Both ions and laser (with an appropriate wavelength) can interact with silicon and generate charges

•Coulombian Interaction → Ionization

•LET (pC/μm) : $\frac{\partial E}{\partial z}$

•Ionization track

•Track radius

➤Function of the energy

➤Range in Silicon : function of the energy

•Photoelectric effect ($\lambda < 1,1\mu\text{m}$)

•Ionization track

•Track radius

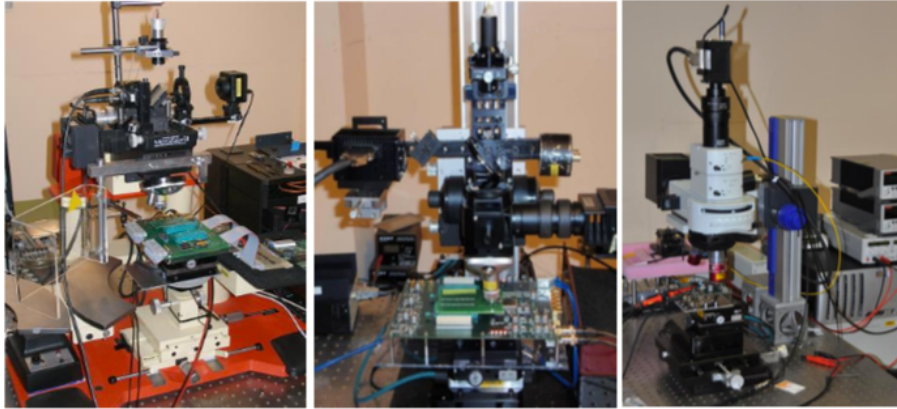
➤Limited by diffraction laws ($\approx 1\mu\text{m}$ for $\lambda=1,06\mu\text{m}$)

•Range in Silicon : function of the wavelength - $>700\mu\text{m}$ for $1,06\mu\text{m}$

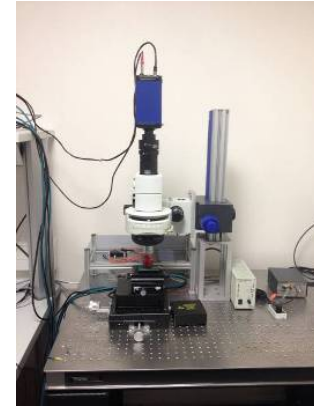
Laser ↔ Ions : not the same basic mechanism
 BUT : same consequence, that is, a localized charge generation

FACILITIES

AIRBUS LASER FACILITIES



NUCLETUDES LASER FACILITY



Single Photon laser

Designed for backside irradiation

Pulsed Laser

X100 Objective

Motorized energy attenuator

Optical fibers

XYZ motorized stages
(50nm resolution)

Camera

Compact

Computer driven

01

A LASER TO PERFORM ... WORST CASE ANALYSIS

WORST CASE SET

Mechanisms:

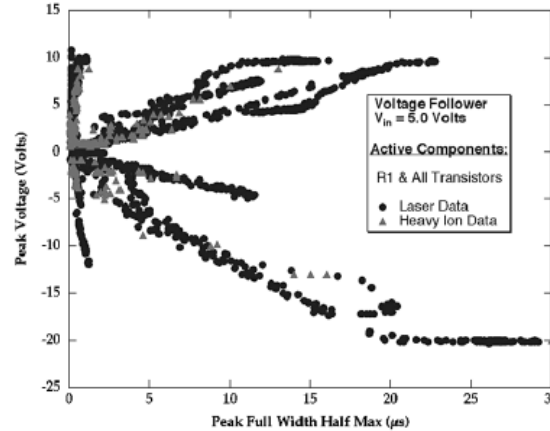
- Combination of a deposited charge & electrical behavior of the device

Conditions:

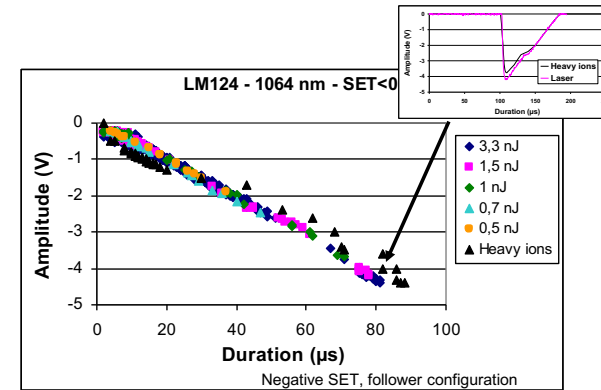
- Various laser energies (shape can change with the energy)

Remarks:

- Maximum laser energy can deposit much more charges than High LET heavy ions → HI test at one LET recommended



SET in LM124 triggered by laser (from [1])



LATCHUP SCREENING

Mechanisms:

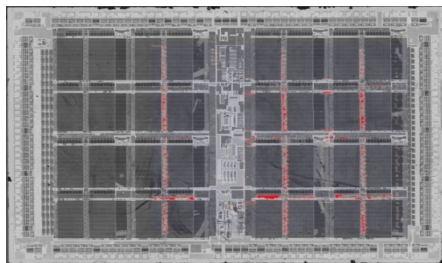
- Combination of a deposited charge to trigger a bipolar parasitic structure & Regenerative feedback

Conditions:

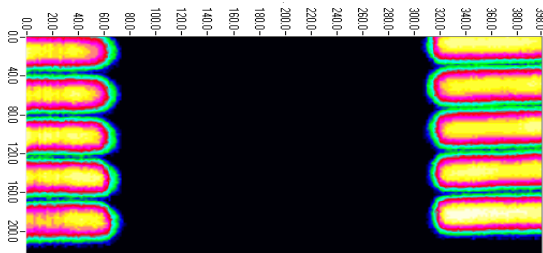
- High laser energy

Remarks:

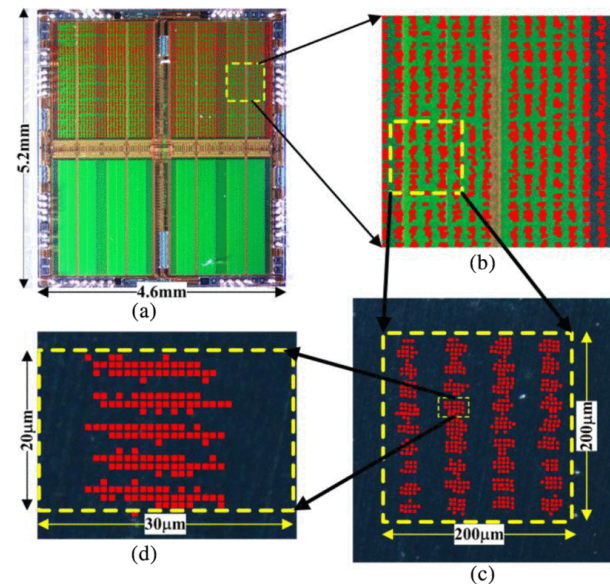
- Sort SEL sensitive device & validate the selected one(s) under beam



Latchup mapping of a MRAM



Latchup mapping of a SRAM



Latchup mapping of a SRAM [1]

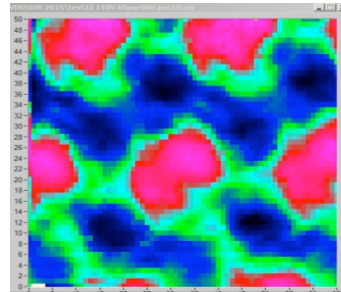
SOA DETERMINATION FOR POWER DEVICES

Mechanisms:

- Combination of a deposited charge to trigger a bipolar parasitic structure & Regenerative feedback

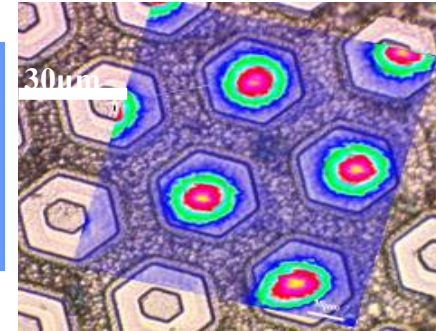
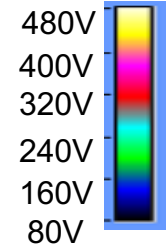
Conditions:

- High laser energy

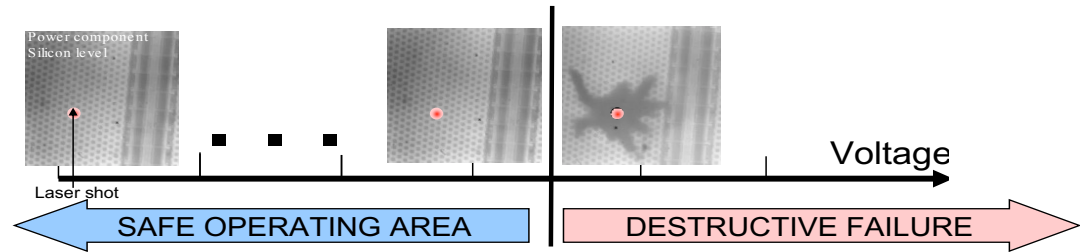


Laser mapping of a power MOSFET

Laser Spot 



Laser mapping of a power MOS



02

A LASER TO PERFORM ... PARAMETRIC TESTING

AS A FUNCTION OF THE BIASING CONFIGURATION

Mechanisms:

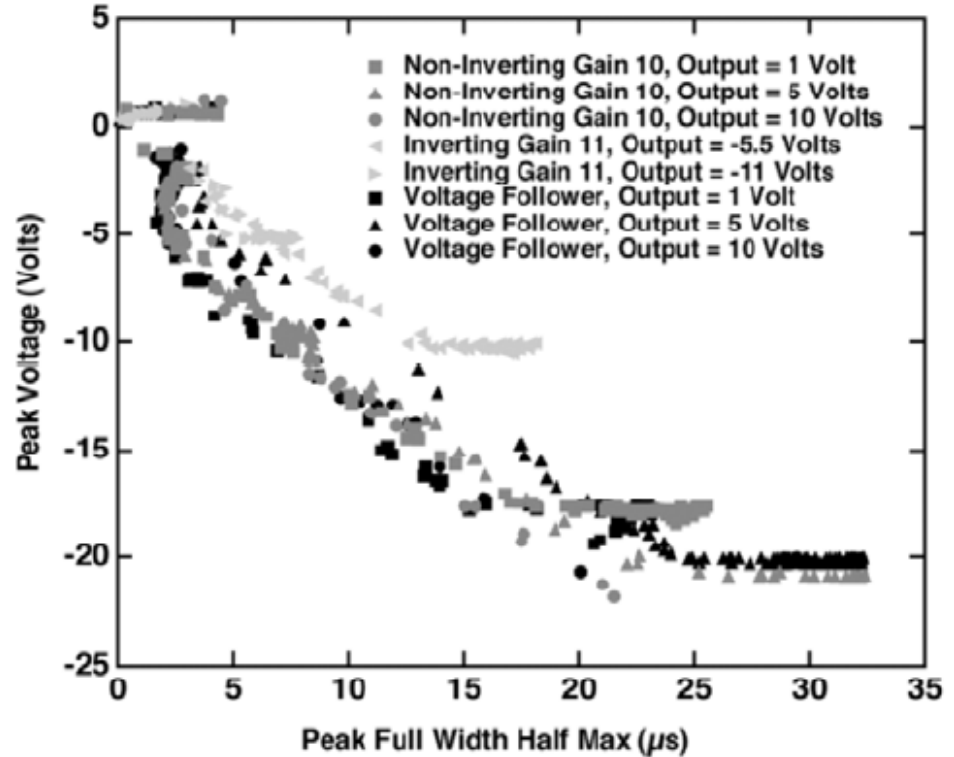
- Combination of a deposited charge & electrical behavior of the device

Conditions:

- Various laser energies (shape can change with the energy)
- Various biasing conditions

Recommendations

- Test at one heavy ion LET to set the laser energies in the range of interest



SET in LM124 as a function of the biasing configuration (from [1])

AS A FUNCTION OF THE TID LEVEL (SYNERGETIC EFFECT)

Mechanisms:

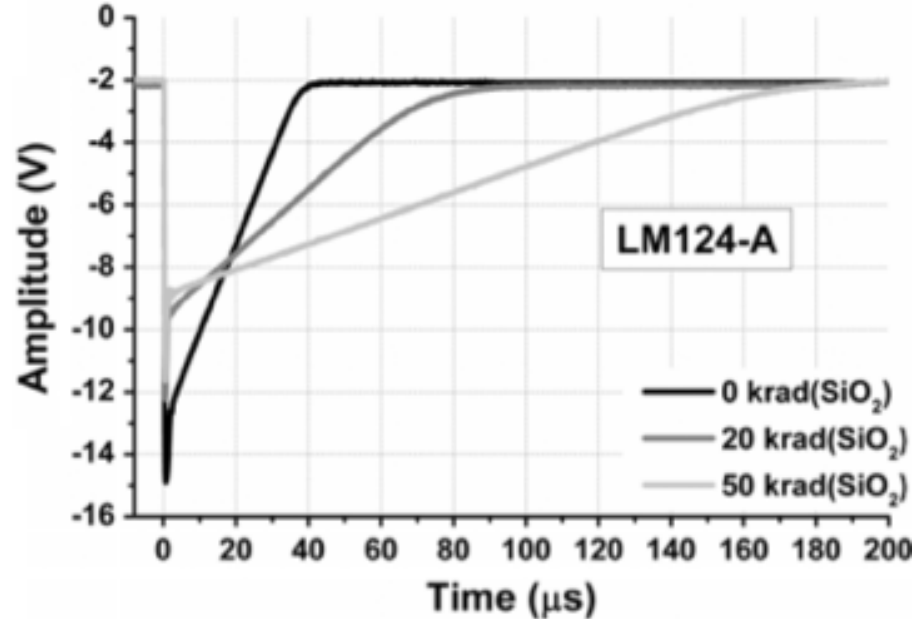
- Combination of a deposited charge & electrical behavior of the device

Conditions:

- Various laser energies (shape can change with the energy)
- Various TID levels

Recommendations

- Test at one heavy ion LET to set the laser energies in the range of interest



Experimental ASETs obtained on Q9 for LM124-A opamps in IWG configuration for pristine and irradiated devices [1].

AS A FUNCTION OF THE RELIABILITY (AGEING)

Mechanisms:

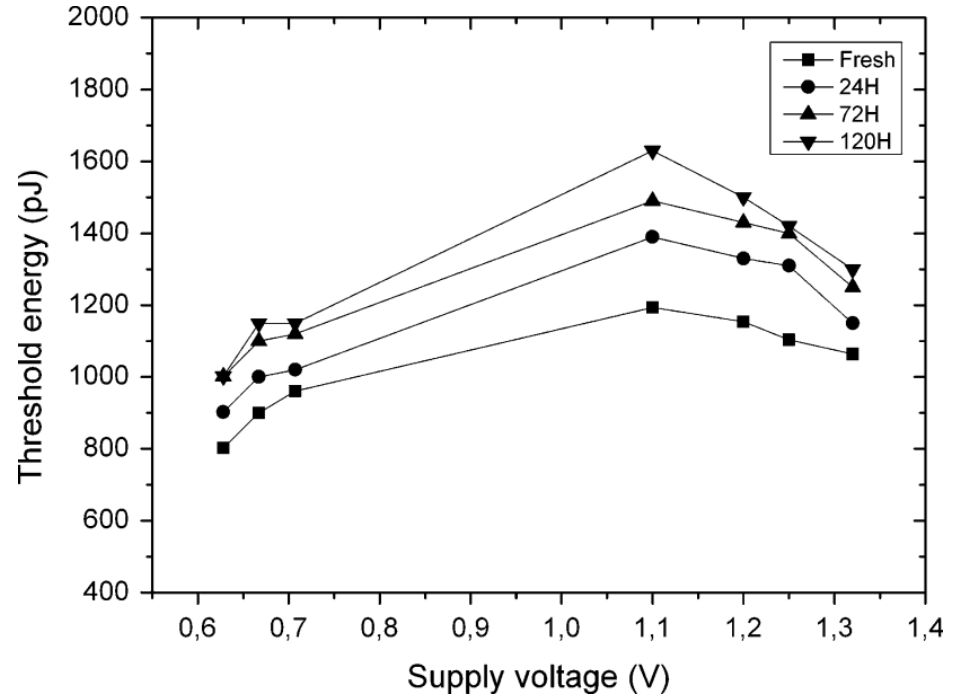
- Combination of a deposited charge & electrical behavior of the device

Conditions:

- Various laser energies
- Different ageing levels

Recommendations

- Test at one heavy ion LET to set the laser energies in the range of interest



SET sensitivity of gates chain before and after aging [1] (NBTI)

AS A FUNCTION OF TEMPERATURE?

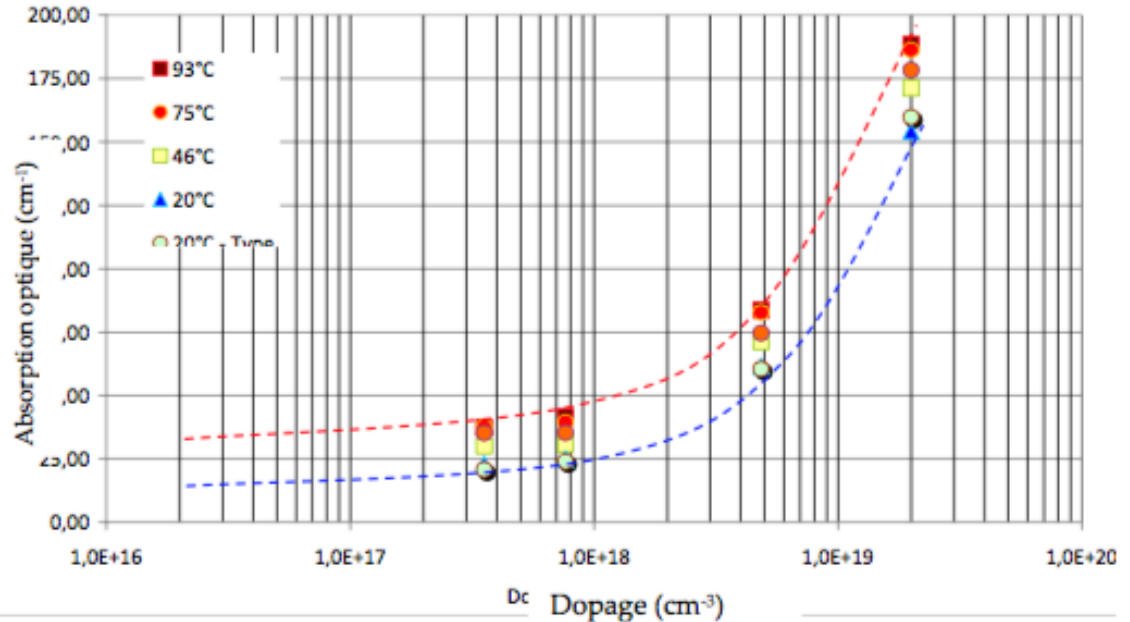
Mechanisms:

- Parametric testing is not as straightforward for some parameters such as T° because of their specific influence on the laser charge deposition

Recommendations

- Test at one heavy ion LET to set the laser energies in the range of interest

BE
CAREFUL!!!



03

A LASER TO PERFORM ... FAULT INJECTION

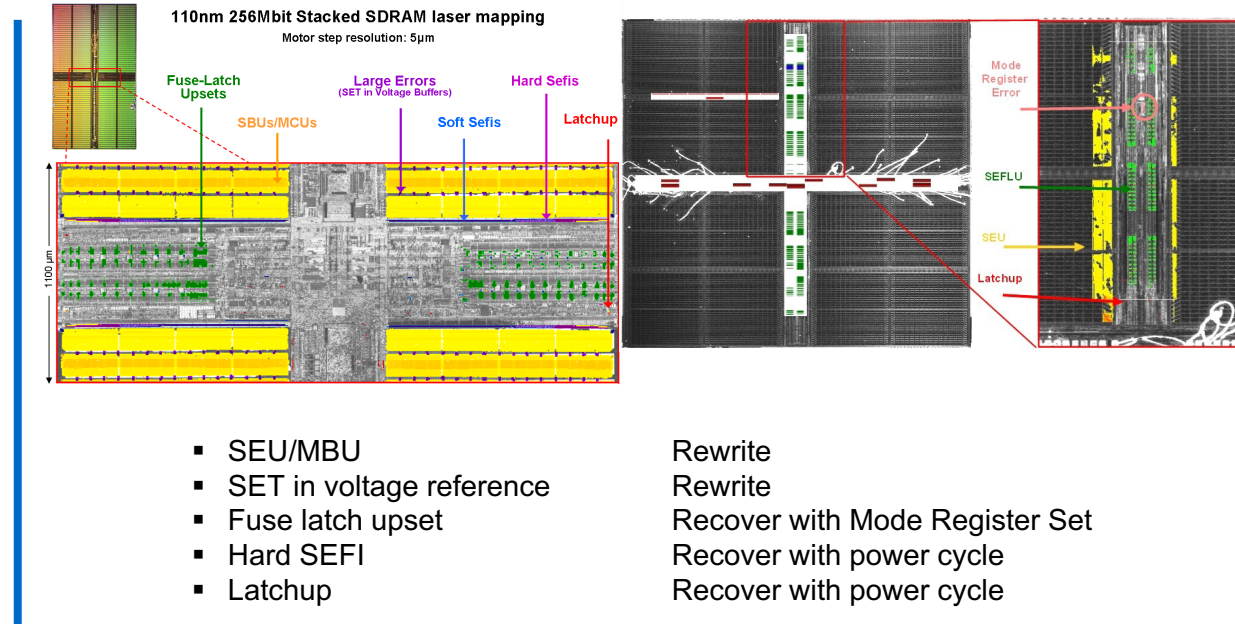
IDENTIFY, SORT SEE & IDENTIFY MITIGATIONS

Conditions:

- Various laser energies (threshold energy mapping)

Remarks

- It is of particular interest prior to an accelerator testing in order to improve and validate the test setup



VALIDATE MITIGATIONS

Conditions:

- Various laser energies

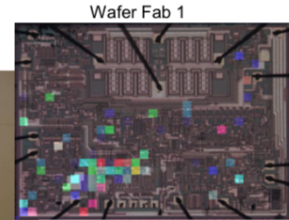
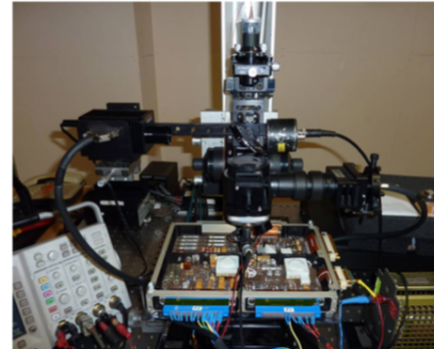
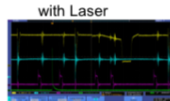
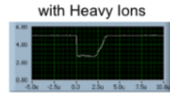
Recommendations

- It is of particular interest prior to an accelerator testing in order to improve and validate the test setup
- One heavy ion LET test to set the laser energies in the range of interest

Astrium Experiences: Mitigation solutions crosscheck 2/2

▪ On Power DC/DC Converter board (cont.)

- To calibrate the laser beam, the laser energy is adjusted in such a way that the transient shape triggered on the Vref pin signal of the PWM matches with the one recorded during the previous heavy ions testing



- **No transient occurred on outputs ⇒ mitigation validated**

Mitigation validation of a DC/DC converter [1]

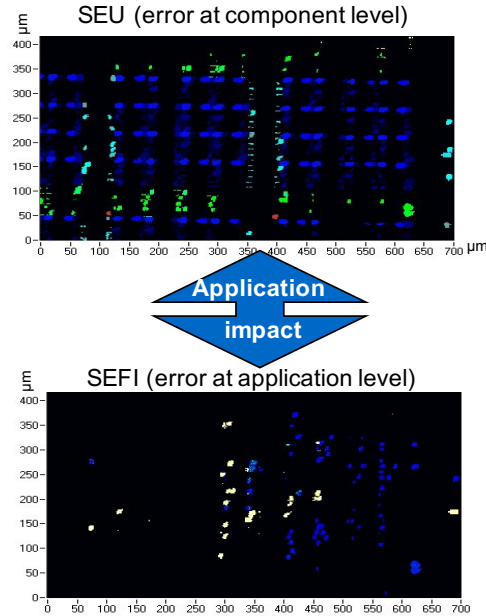
ASSESS IMPACT AT APPLICATION LEVEL

Conditions:

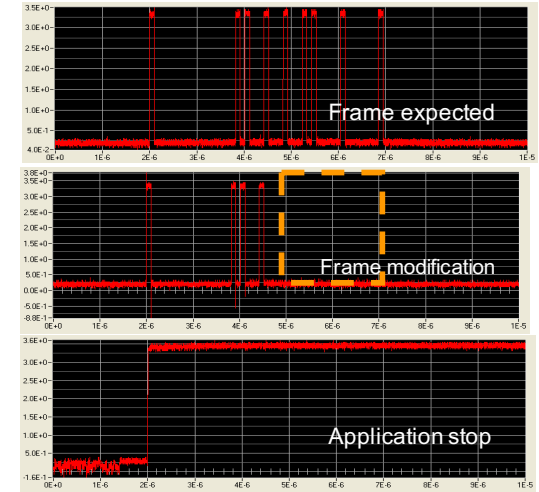
- Laser energies for which errors are triggered at component level

Remarks

- As for a test under beam, it may be difficult to be exhaustive depending on the complexity of the application layer



180nm FPGA running a communication application
(color scale ⇔ kind of resource impacted)



04

A LASER TO PERFORM ...

FUNCTIONAL REVERSE ENGINEERING

REVEAL ARCHITECTURE OF DIGITAL ICs

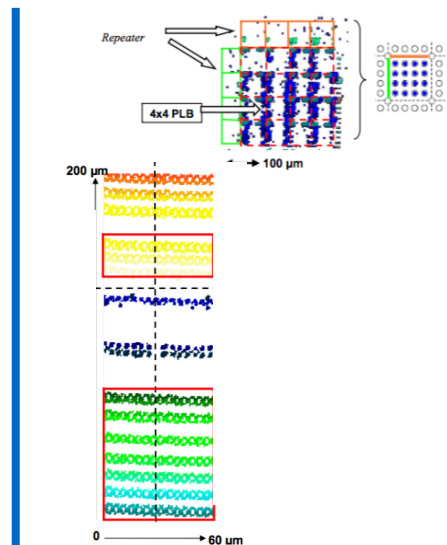
Conditions:

- Laser threshold mapping

Remarks

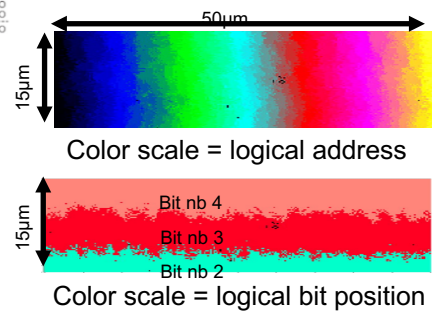
- Key parameters for the MBU prediction & ECC efficiency evaluation

130nm FPGA



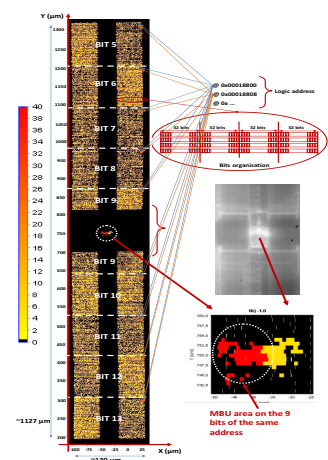
130nm FPGA CRAM laser mapping

90nm SRAM



High probability to have MBUs (less than 10μm between bits of the same word)

40 nm FPGA



40nm FPGA BRAM laser mapping

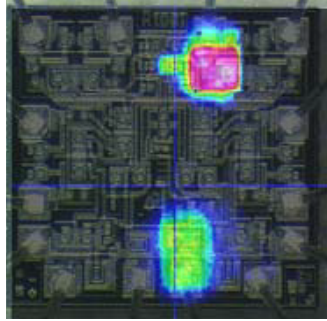
LOCATE & ESTIMATE THE NUMBER OF SENSITIVE VOLUMES

Conditions:

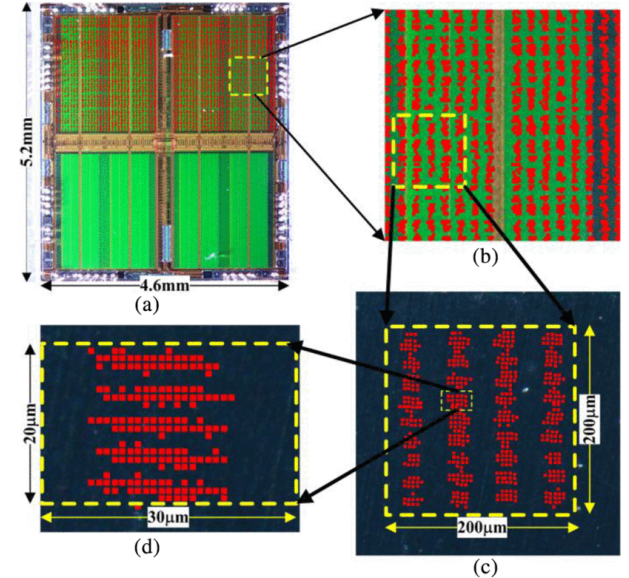
- High laser energy

Remarks

- The location of sensitive areas is a valuable information for IC designers and the number of sensitive volumes may be useful for prediction approaches



Latchup mapping of a comparator



Latchup mapping of a SRAM [1]

04

A LASER TO PERFORM ... CROSS SECTION EVALUATION

EQUIVALENT HEAVY ION CROSS SECTION?

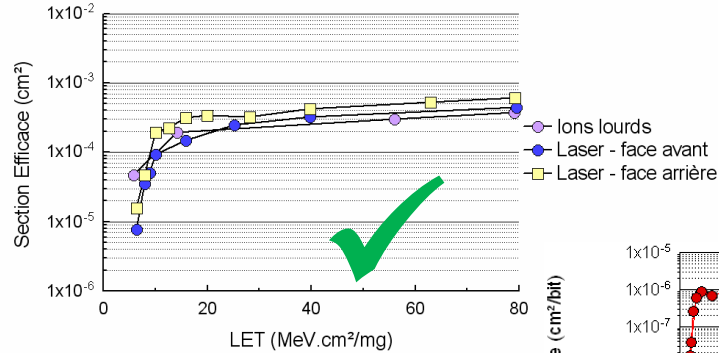
Conditions:

- Various laser energies (threshold energy mapping)

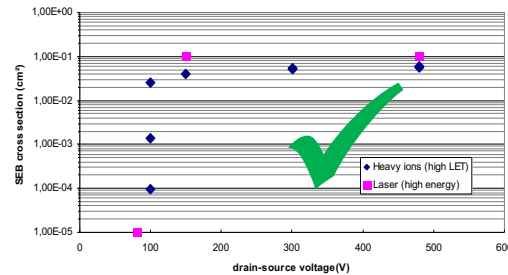
Remarks

- Due to the spot size effects, direct XS correlation between laser and heavy ions should be handled carefully for integrated devices

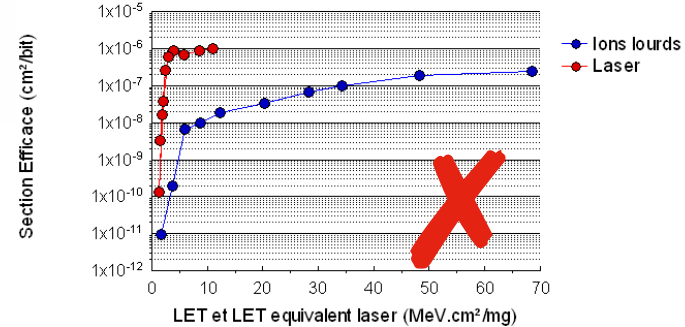
BE
CAREFUL!!!



Laser and heavy ion XS for a LM139



Laser and heavy ion XS for a 500V powerMOSFET



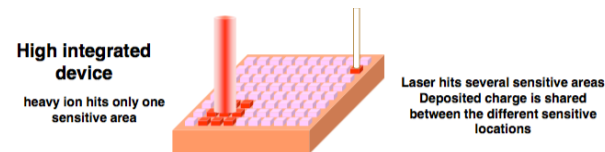
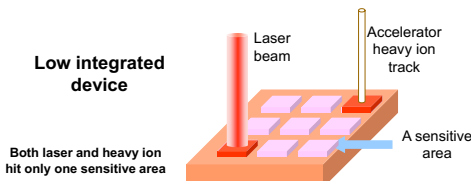
EQUIVALENT HEAVY ION CROSS SECTION?

Conditions:

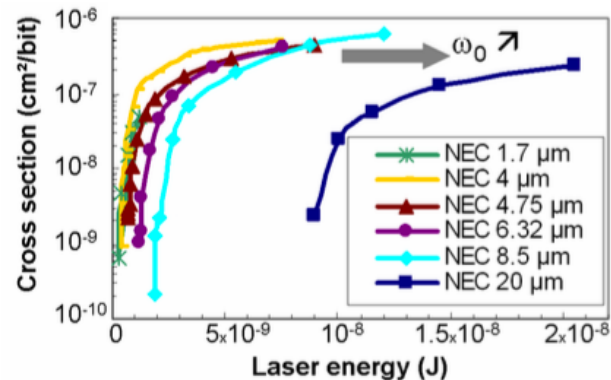
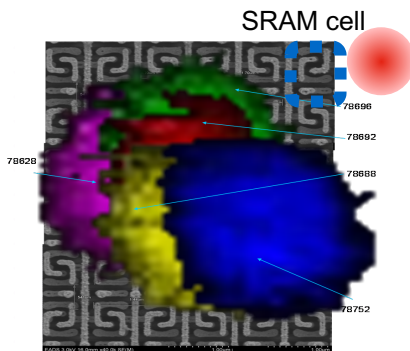
- Various laser energies (threshold energy mapping)

Remarks

- Due to the spot size effects, direct XS correlation between laser and heavy ions should be handled carefully for integrated devices



90nm SRAM



BE CAREFUL!!!

05

CONCLUSIONS

Conclusions

- Review of the main SPA laser test methodologies
- Not exhaustive, many more methodologies studied
- Not limited to silicon, applicability to SPA in wide band gap
- Laser should be considered as a complementary tool to accelerators → may require a HI test at one LET to set the energy range

Be aware of

- Temperature
- Comparison of devices with different feature sizes

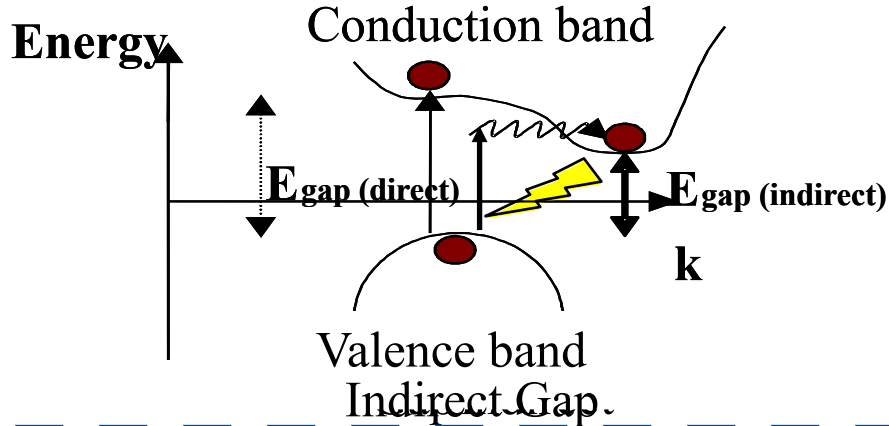
Worst case	SET
	SEL
	SEB
Parametric	Biasing configurations
	TID
	Ageing
	Temperature
Fault injection	Identification of SEE
	Identification of mitigations
	Validation of mitigations
	Application impact
Functional reverse	Architecture of digital ICs
	Sensitive volume localization
Cross section	Low integration level
	High integration level

06

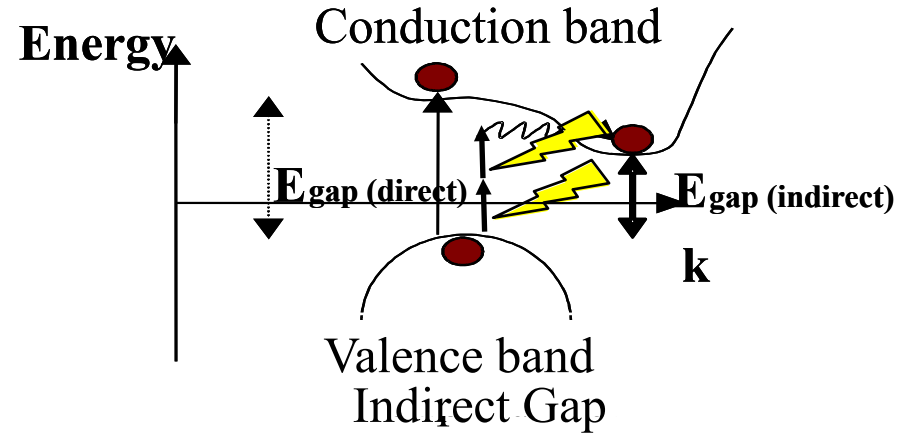
BACKUP

SPA VS TPA

Single Photon Absorption

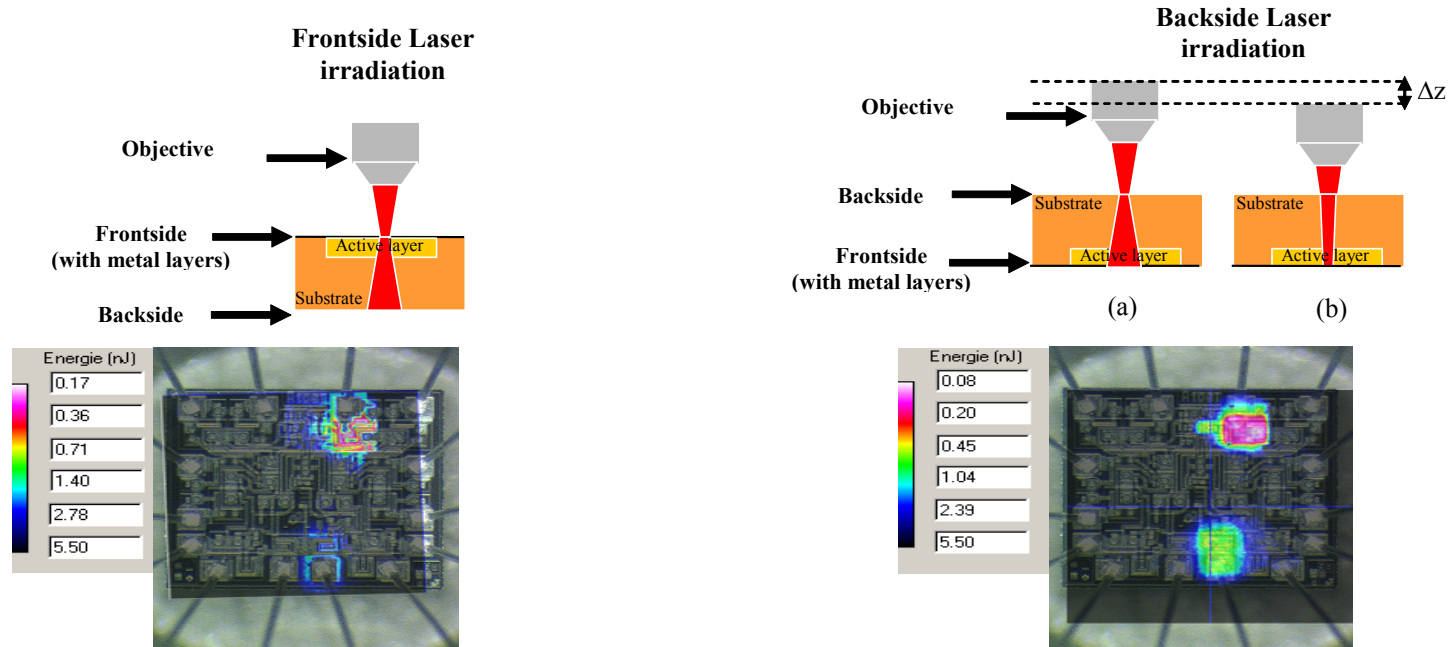


Two Photon Absorption



	Single Photon Absorption	Two Photon Absorption
Stability	Green	Orange
Minimum spot size	Light Green	Green
Sensitive thickness probing	Orange	Green
Cost	Green	Red
Ease to use	Green	Orange
Theoretical resolution	Light Green	Orange

Backside irradiation



- Laser can't cross metal layers :
Problem due to metal opacity

Part of the sensitive areas are not revealed

- No problem due to metal opacity
- Need a backside opening (but now, flip chipped devices)

Backside laser testing reveals all the sensitive areas